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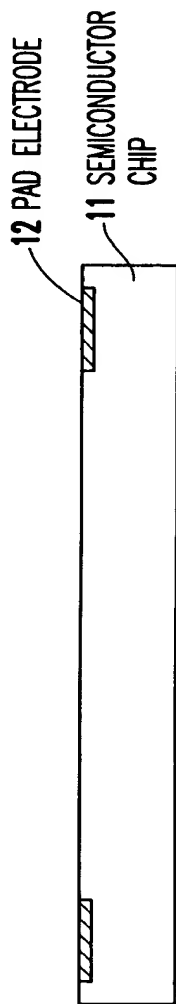


FIG. 2A  
PRIOR ART

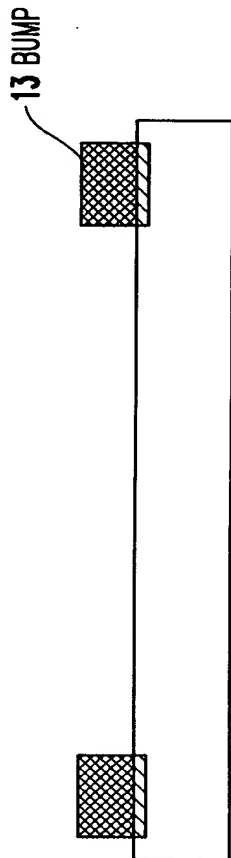


FIG. 2B  
PRIOR ART

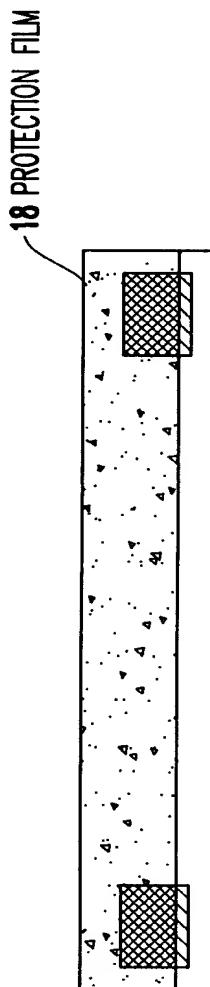


FIG. 2C  
PRIOR ART



FIG. 2D  
PRIOR ART



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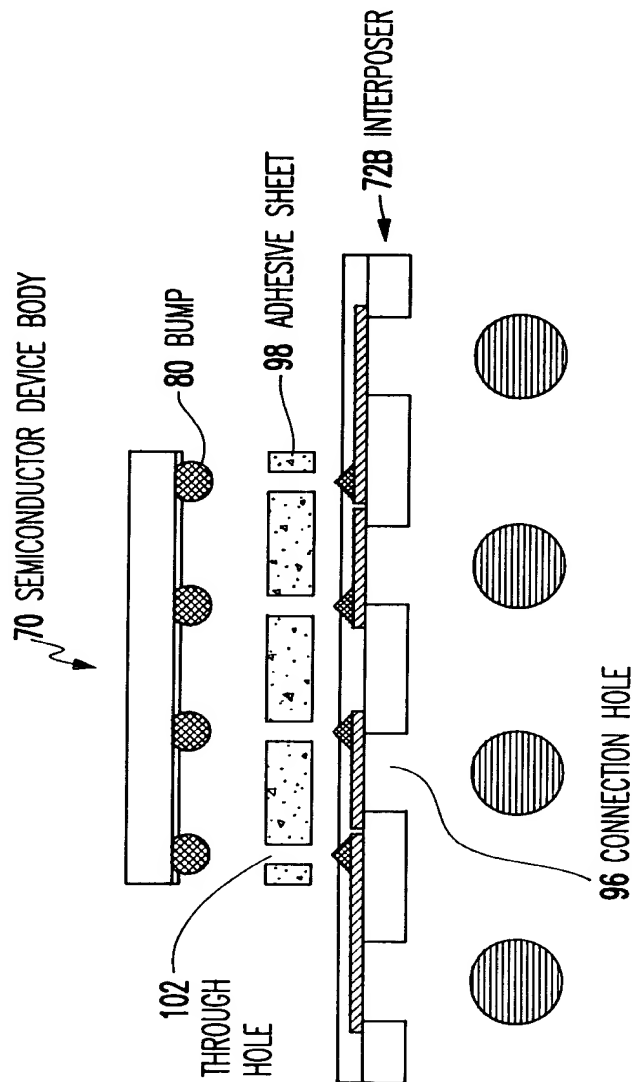


FIG.3  
PRIOR ART

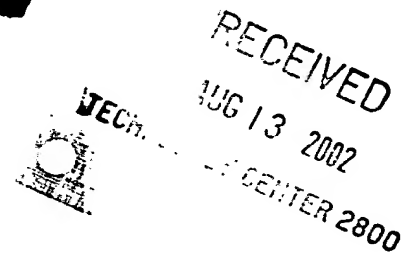


FIG.4A

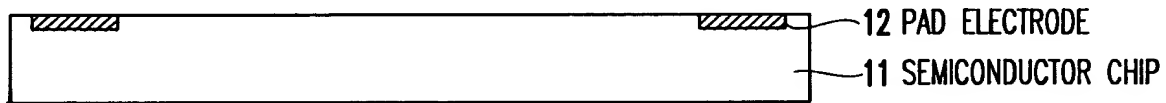


FIG.4B

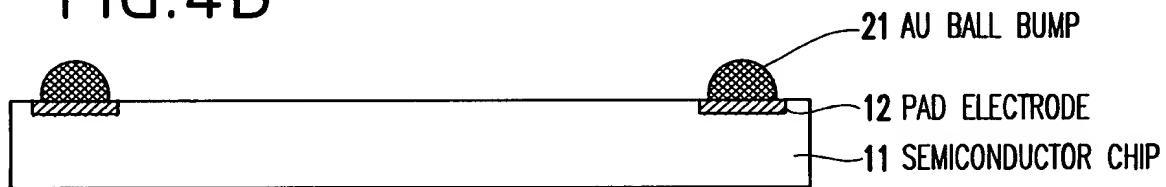


FIG.4C

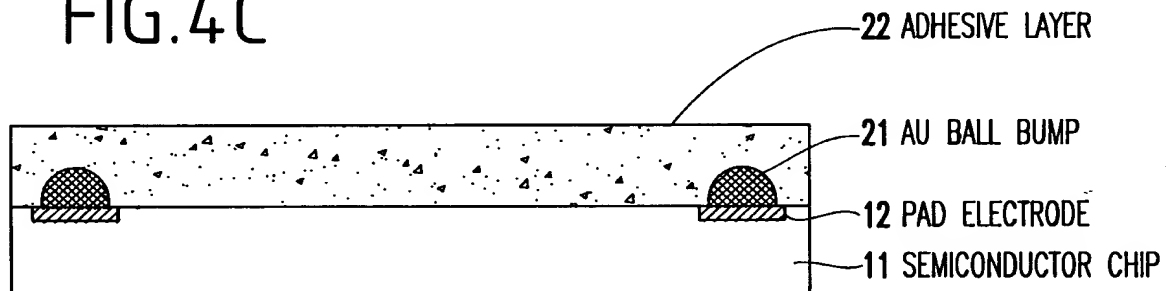
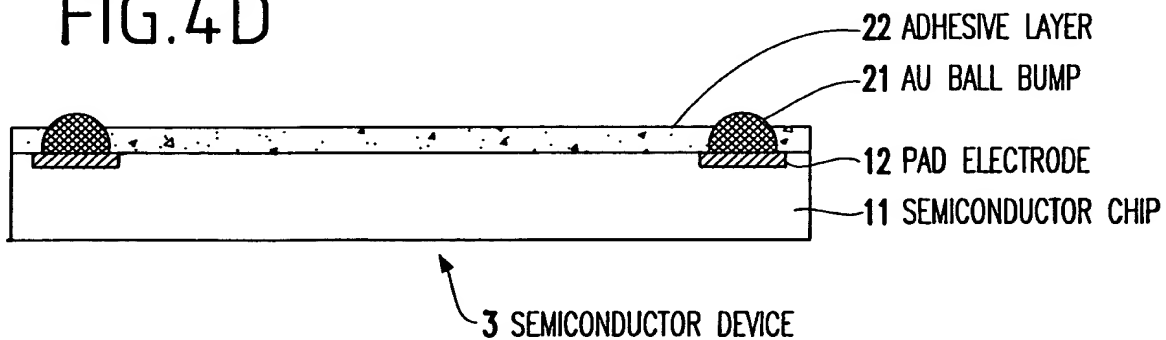


FIG.4D



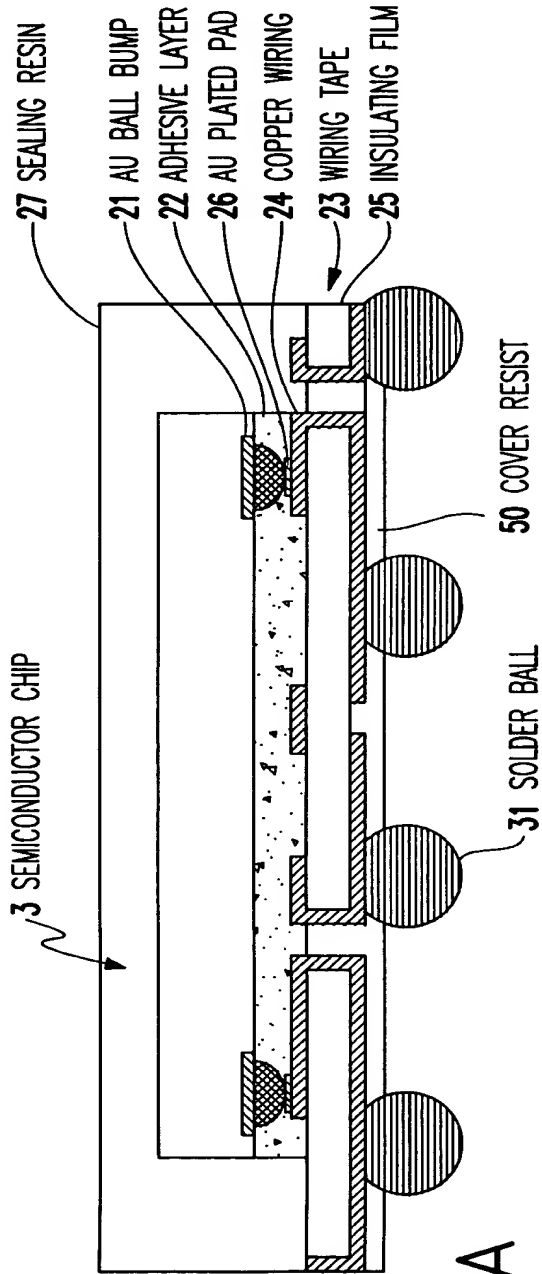


FIG. 5A

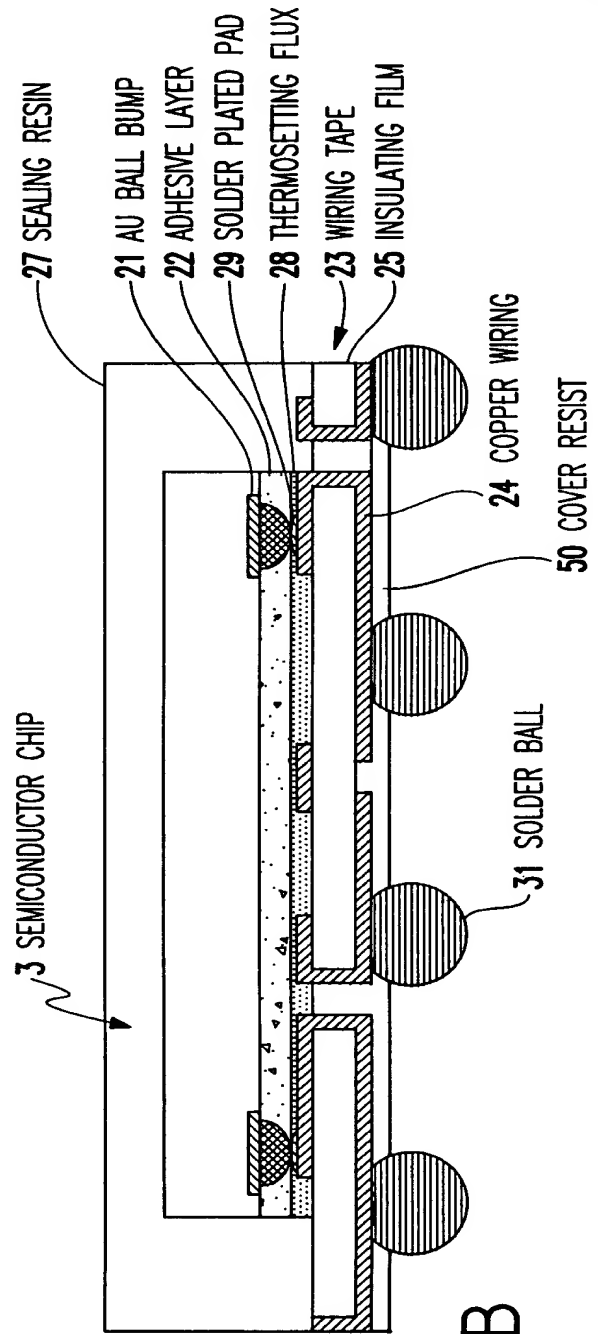


FIG. 5B

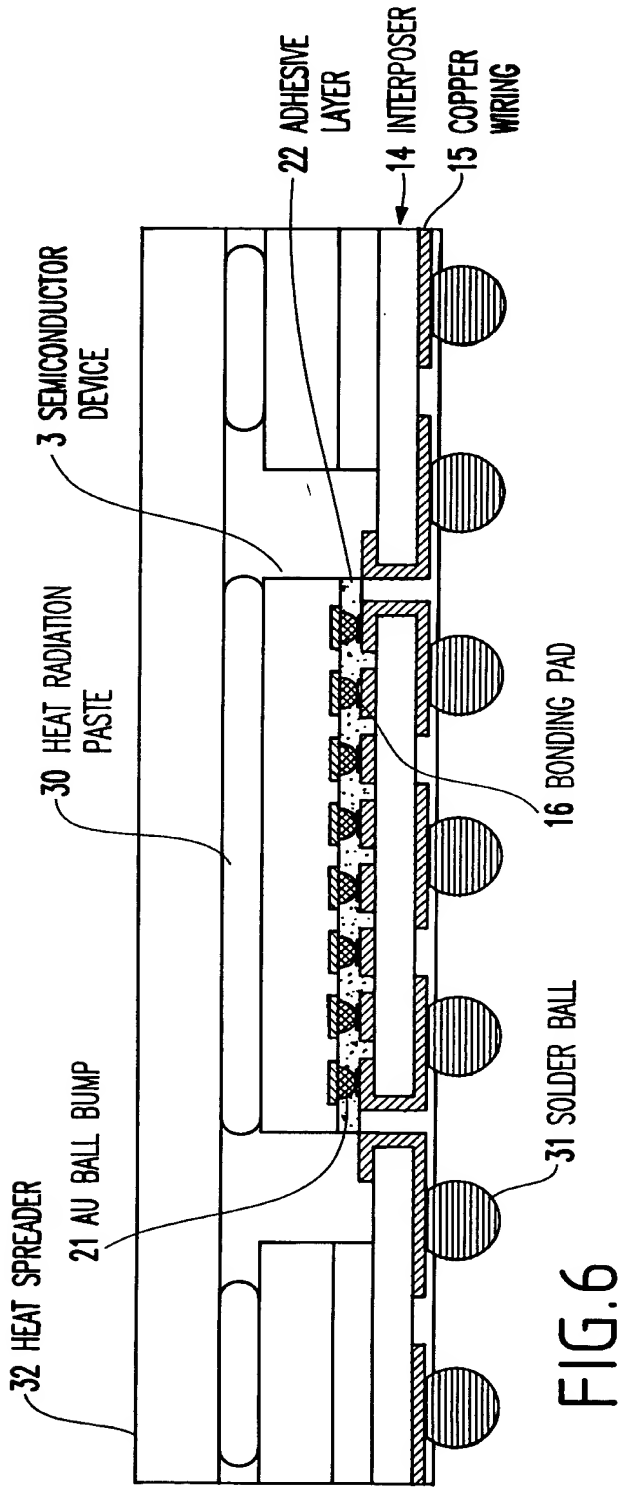


FIG. 6

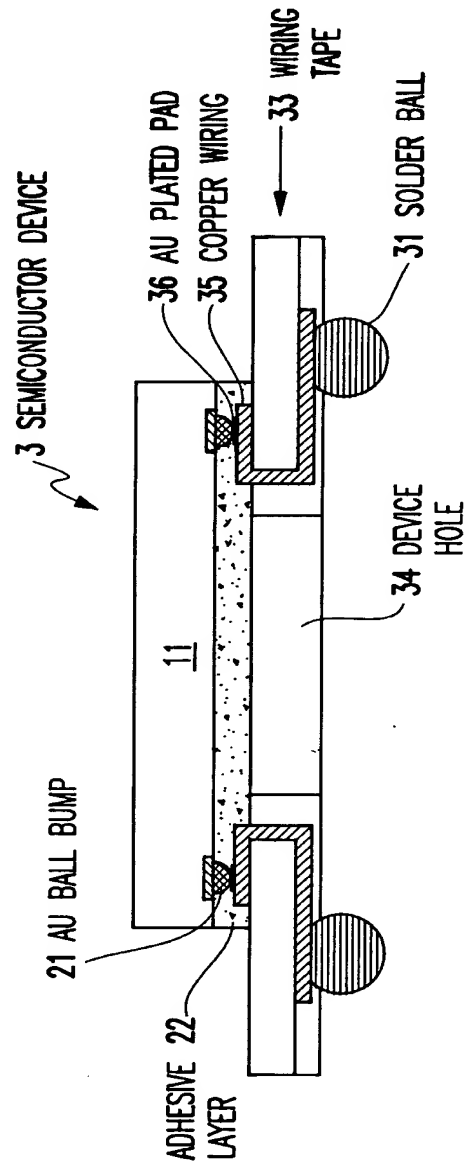


FIG. 7

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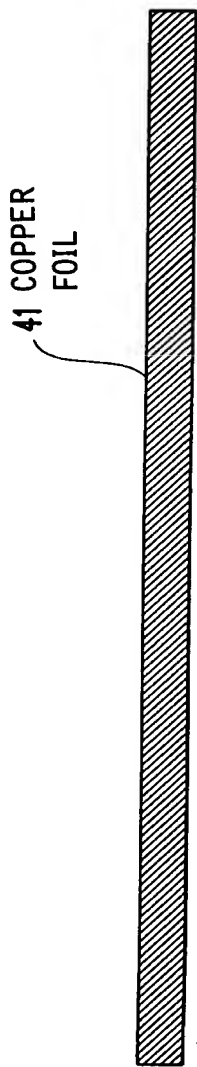


FIG. 8A

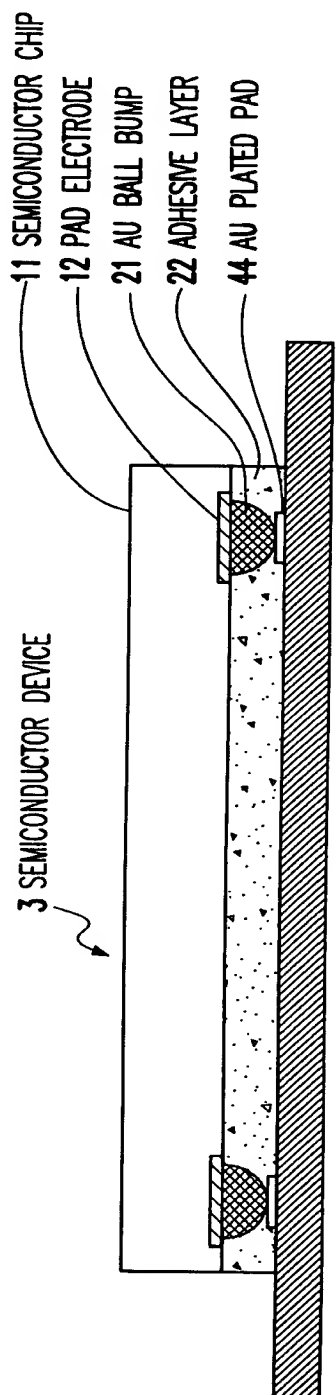


FIG. 8B

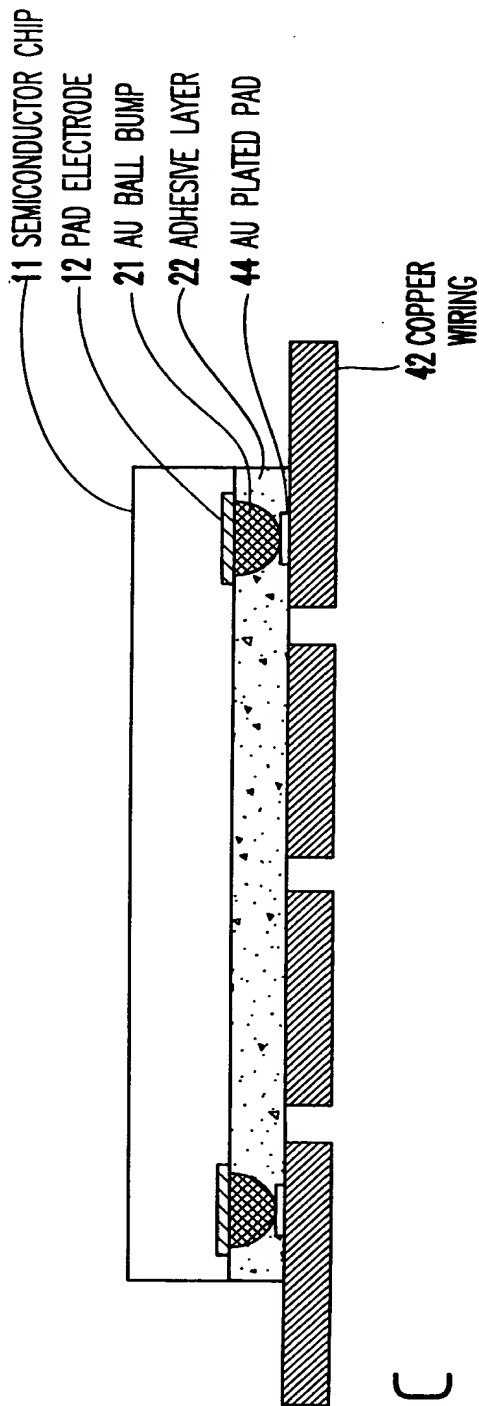


FIG. 8C

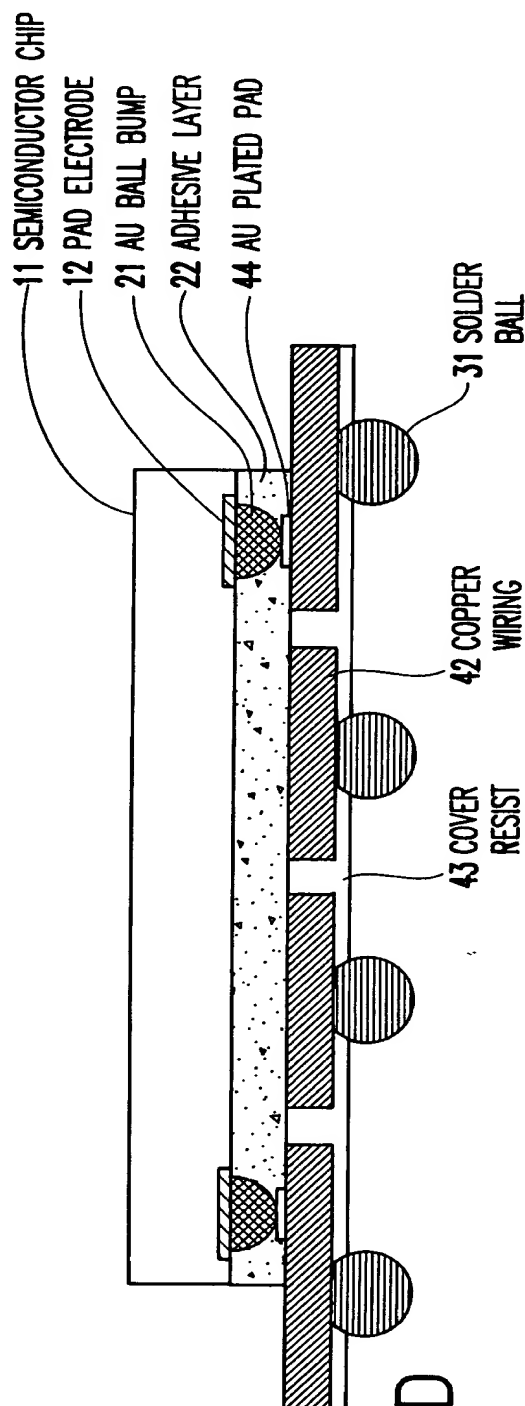


FIG. 8D



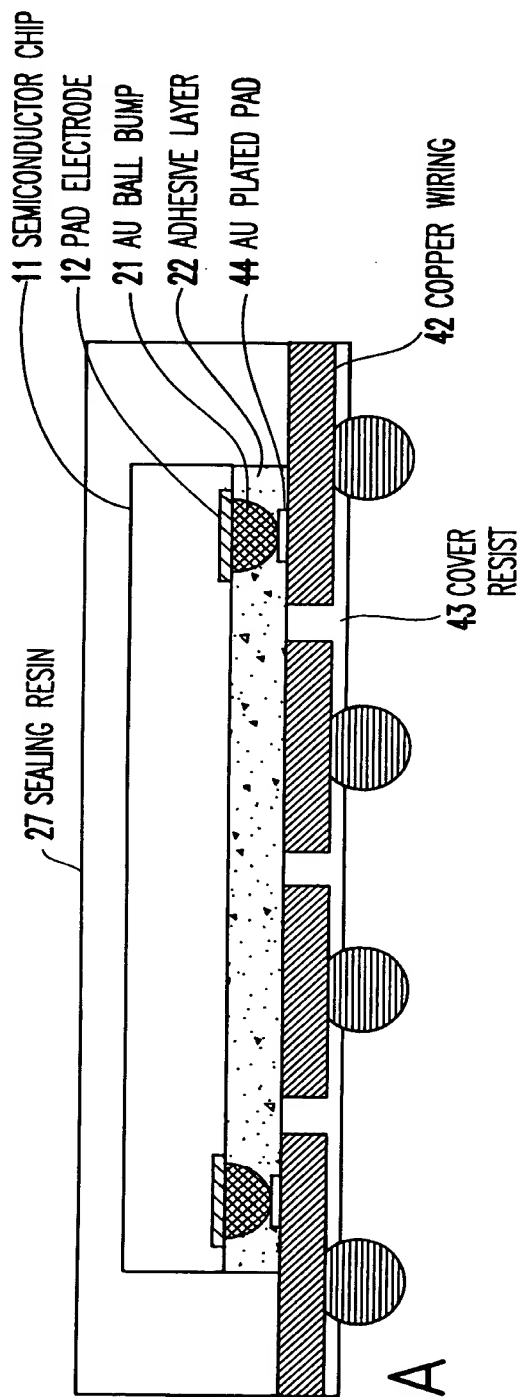


FIG. 9A

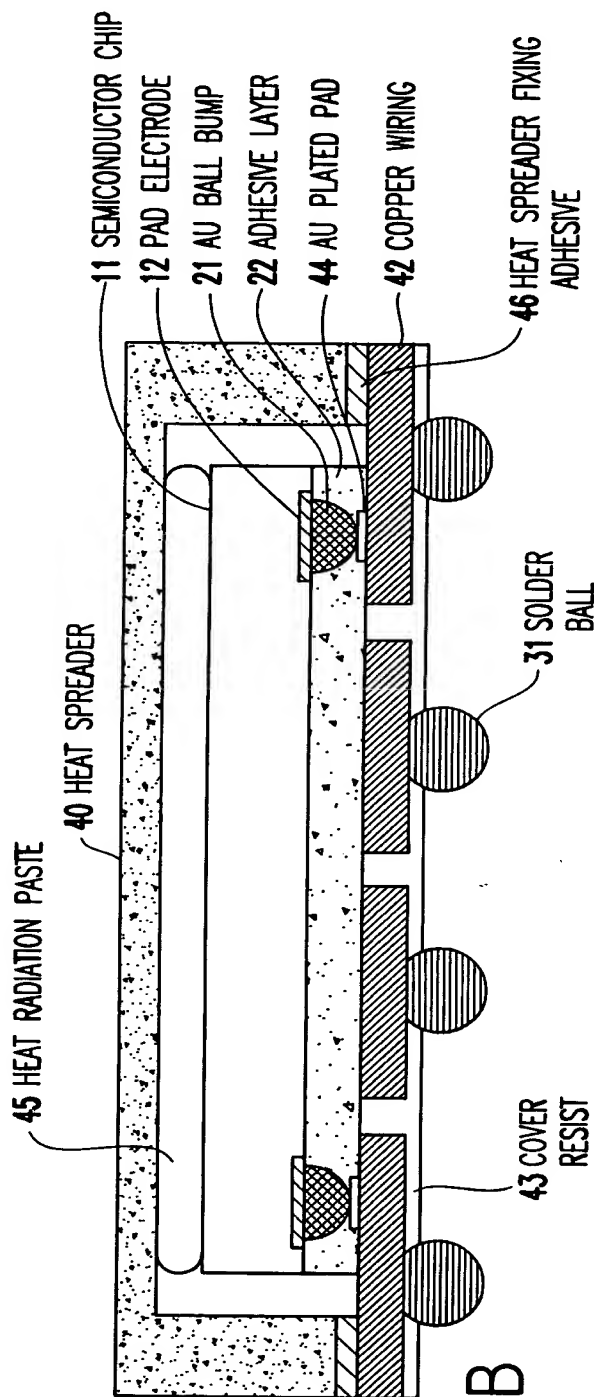


FIG. 9B

FIG. 10A

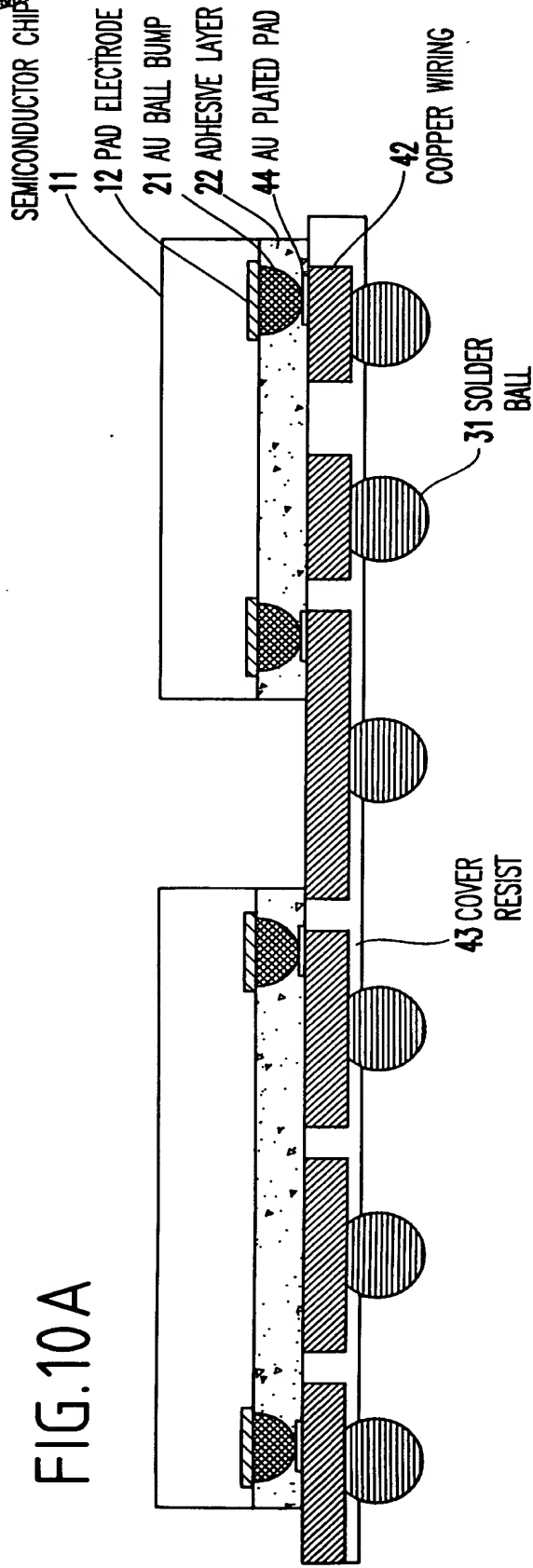
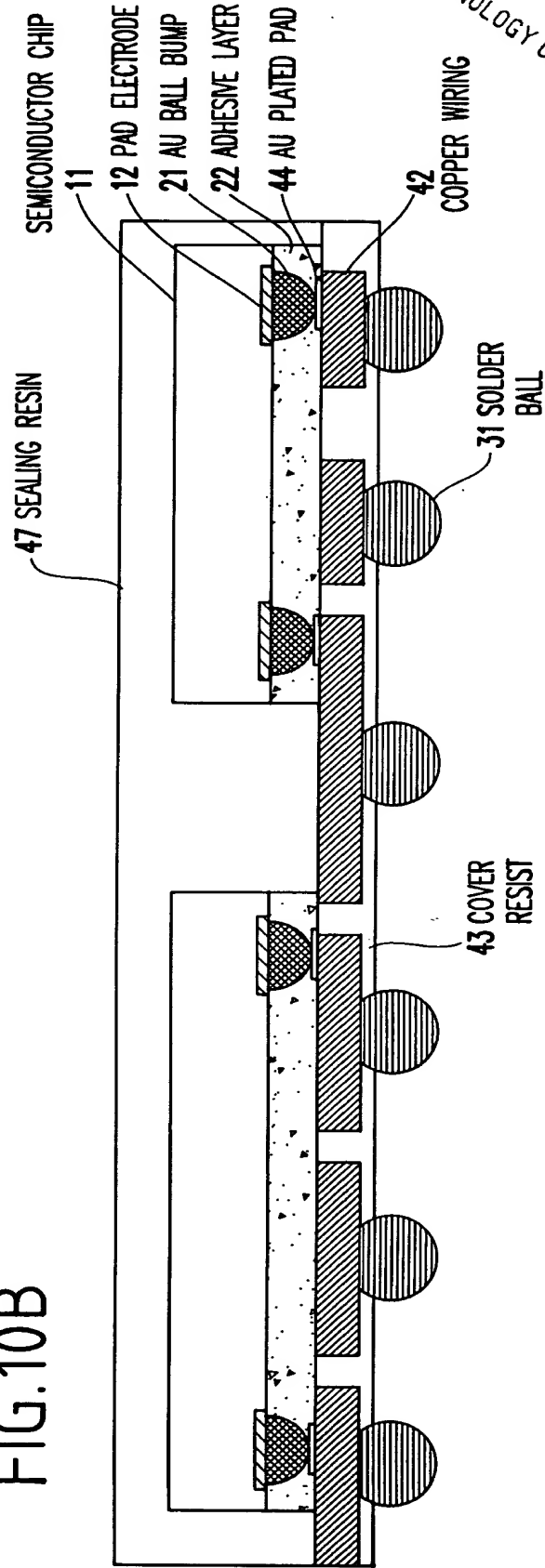


FIG. 10B



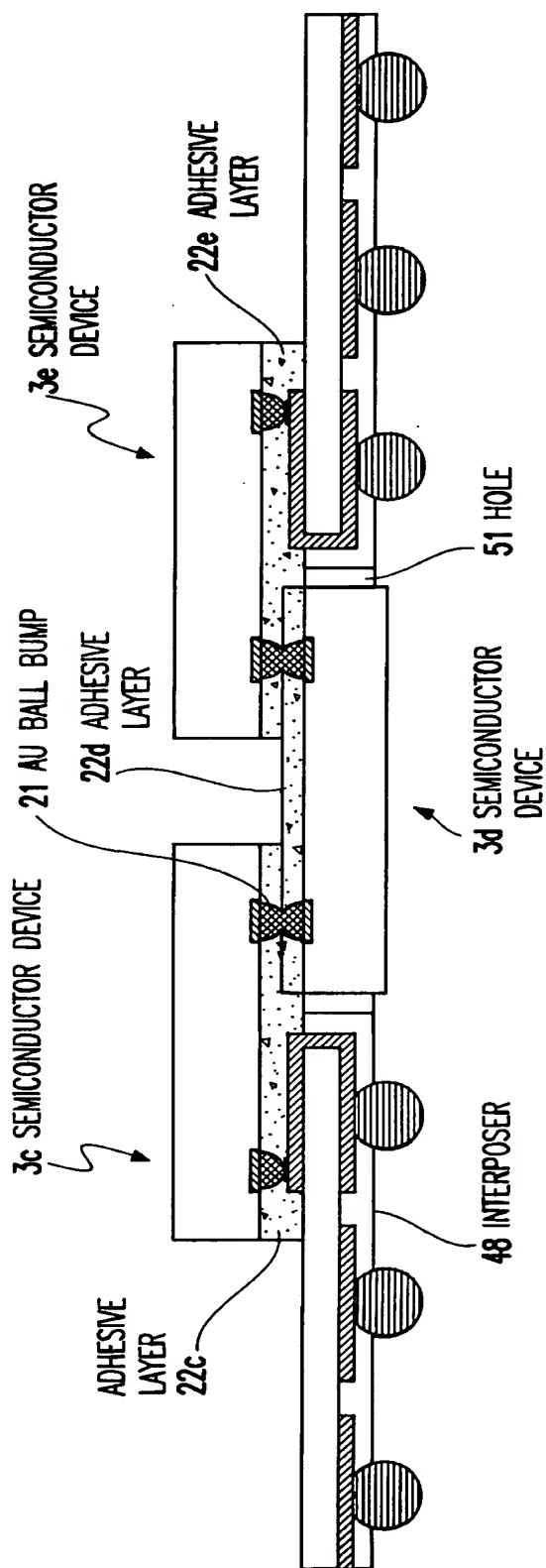


FIG. 11A

FIG. 11C

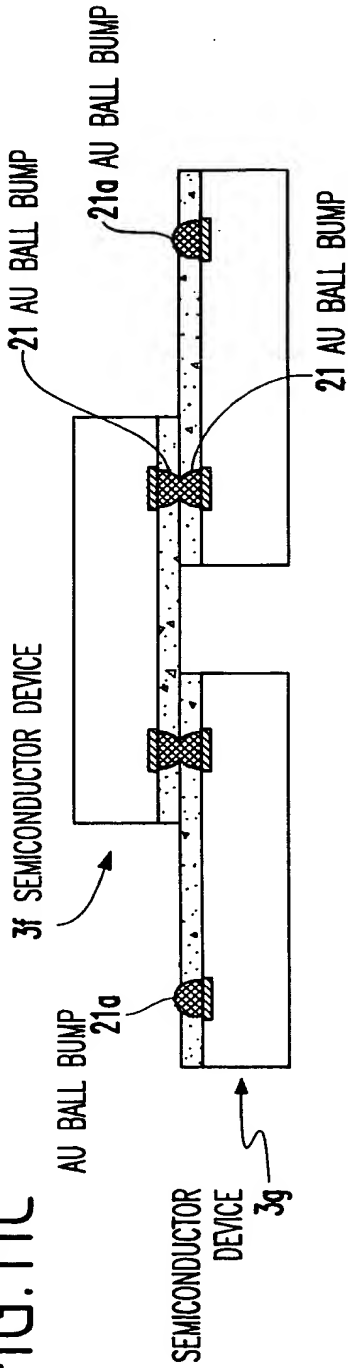
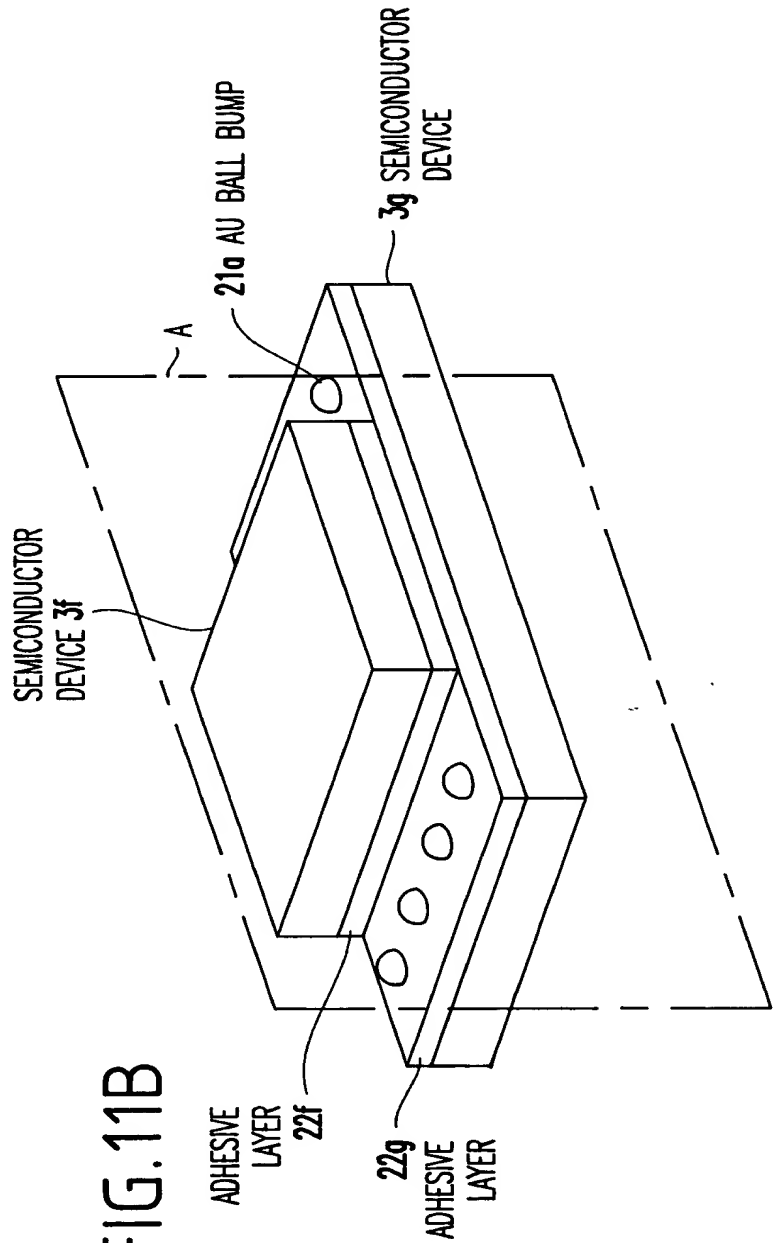


FIG. 11B



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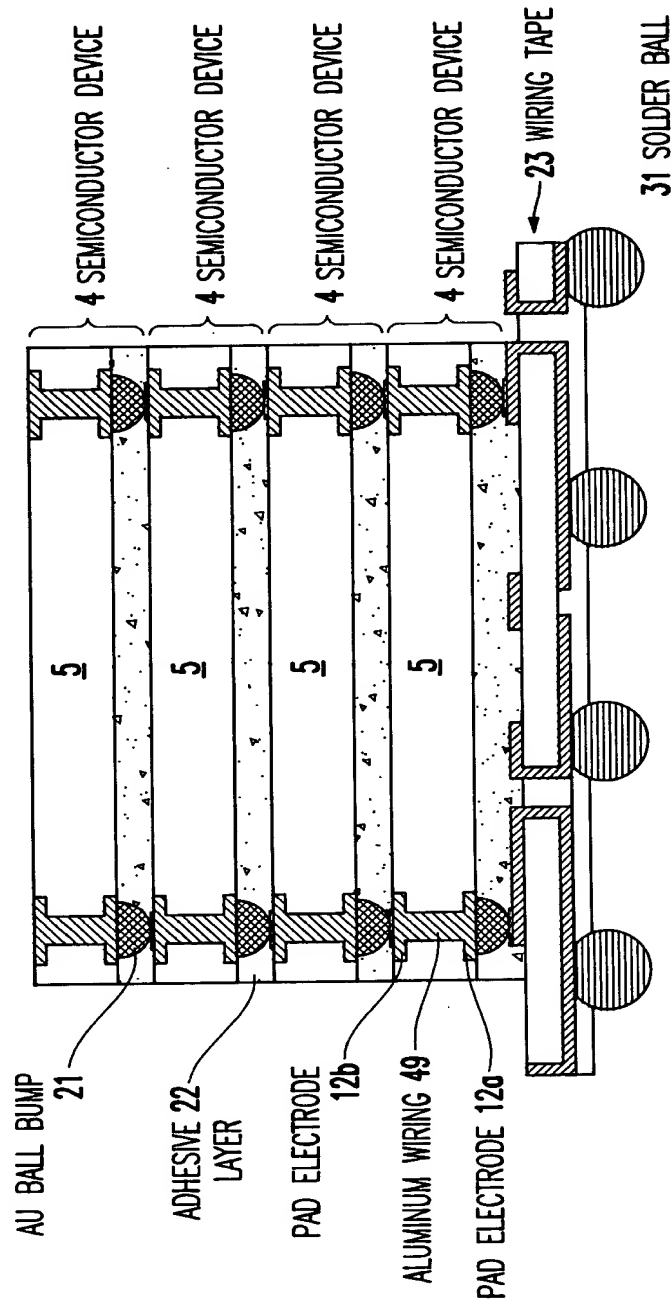


FIG.12

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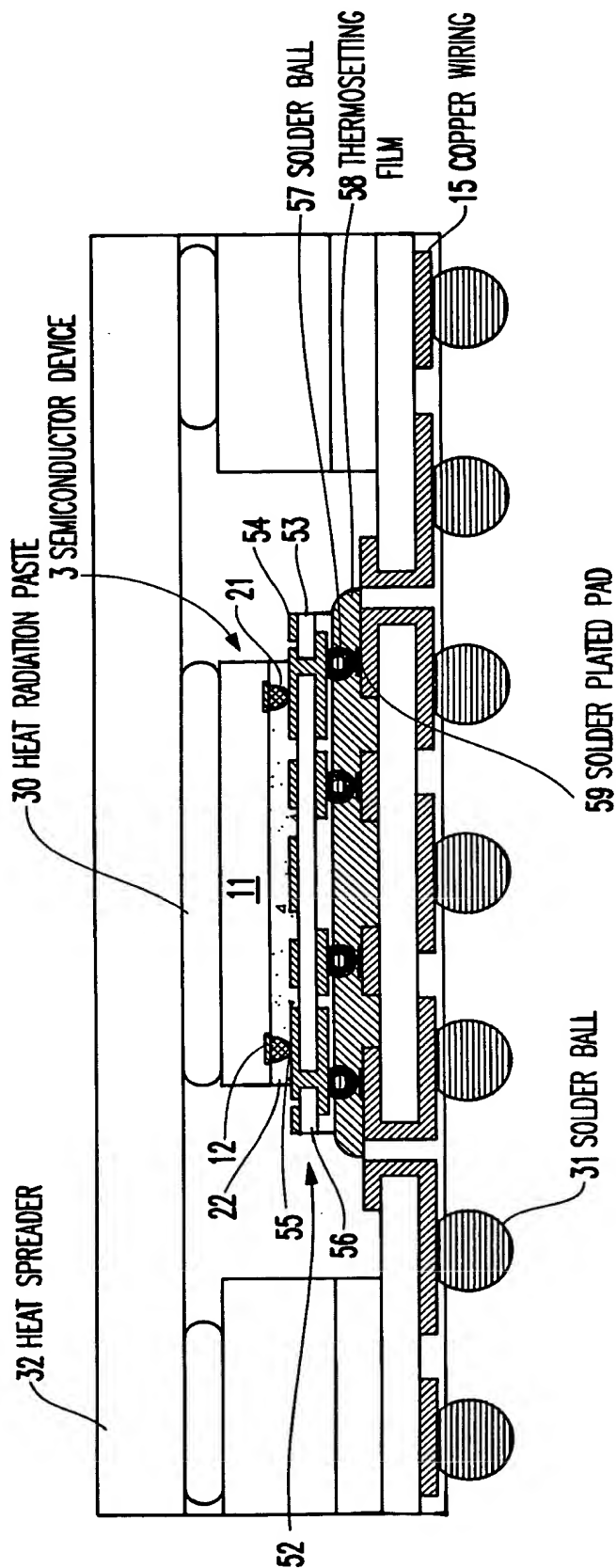


FIG.13